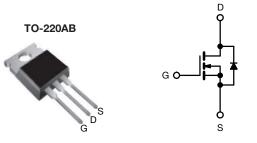
Vishay Siliconix

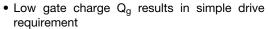
## **Power MOSFET**



N-Channel	

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	500			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 0.26			
Q <sub>g</sub> max. (nC)	120			
Q <sub>gs</sub> (nC)	34			
Q <sub>gd</sub> (nC)	54			
Configuration	Single			

#### **FEATURES**





• Improved gate, avalanche, and dynamic dV/dt ruggedness

- Fully characterized capacitance and avalanche voltage and current
- Low R<sub>DS(on)</sub>
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

#### **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching
- · Hard switched and high frequency circuits

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free	IRFB18N50KPbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	500	.,,	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1_	17	А	
Continuous drain current	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	11		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	68		
Linear derating factor				1.8	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	370	mJ	
Repetitive avalanche current a			I <sub>AR</sub>	17	Α	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	22	mJ	
Maximum power dissipation $T_C = 25  ^{\circ}C$		P <sub>D</sub>	220	W		
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	7.8	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) d For 10 s		0 s		300	°C	
Mounting torque	6-32 or M	3 screw		10	N	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. Starting  $T_J$  = 25 °C, L = 2.5 mH,  $R_G$  = 25  $\Omega,\,I_{AS}$  = 17 A
- c.  $I_{SD} \le 17$  A,  $dI/dt \le 376$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C
- d. 1.6 mm from case



# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient <sup>a</sup>	R <sub>thJA</sub>	-	58	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum junction-to-case (drain) a	R <sub>thJC</sub>	-	0.56	

#### Note

a. R<sub>th</sub> is measured at T<sub>J</sub> approximately 90 °C

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					L	L	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 250 μA	500	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.59	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> :	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>		= 500 V, V <sub>GS</sub> = 0 V /, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	50 250	μΑ
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 400 \text{ V}$	$I_D = 10 \text{ A}^b$		0.26	0.29	Ω
Forward transconductance	9fs		= 50 V, I <sub>D</sub> = 10 A	6.4	-	-	S
Dynamic	918	1 105	- 55 7, 10 - 15 77	0. 1			
Input capacitance	C <sub>iss</sub>	T T	V 0.V	_	2830	_	1
Output capacitance	C <sub>oss</sub>	1	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		330	_	•
Reverse transfer capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	_	38	-	
'	C <sub>oss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	3310	-	pF
Output capacitance			V <sub>DS</sub> = 400 V, f = 1.0 MHz	-	93	-	
Effective output capacitance	C <sub>oss</sub> eff.	1 3	V <sub>DS</sub> = 0 V to 400 V c	-	155	_	1
Total gate charge	Qq			-		120	
Gate-source charge	Q <sub>gs</sub>	1	$I_D = 17 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 b	-	-	34	nC
Gate-drain charge	Q <sub>gd</sub>	1	see lig. 6 and 13	-	-	54	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> = 10 V		-	22	-	
Rise time	t <sub>r</sub>	1	$V_{DD} = 250 \text{ V}, I_D = 17 \text{ A},$	-	60	-	1
Turn-off delay time	t <sub>d(off)</sub>	1	$R_G = 7.5 \Omega$ , see fig. 10 b	-	45	-	ns
Fall time	t <sub>f</sub>	1		-	30	-	
Gate input resistance	Rg	f = 1 MHz, open drain		0.7	-	2.7	Ω
Drain-Source Body Diode Characteristic	cs						•
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the		=	-	17	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction	<u></u>	-	-	68	A
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V b	-	-	1.5	٧
Body diode reverse recovery time	t <sub>rr</sub>	-		-	520	780	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_J = 25  ^{\circ}\text{C}, I_F$	= 17 A, $dI/dt = 100 A/\mu s^b$	-	5.3	8.0	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic to	ırn-on time is negligible (turn	on is dor	ninated h	v I c and	[P]

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %
- c.  $C_{oss}$  eff. is a fixed capacitance that givs the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

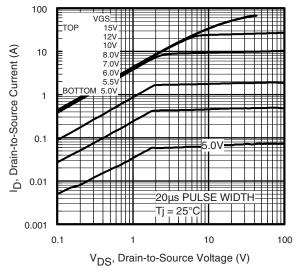


Fig. 1 - Typical Output Characteristics

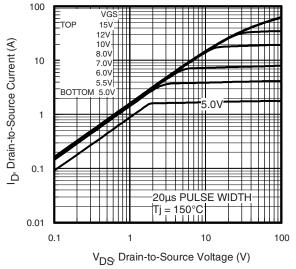


Fig. 2 - Typical Output Characteristics

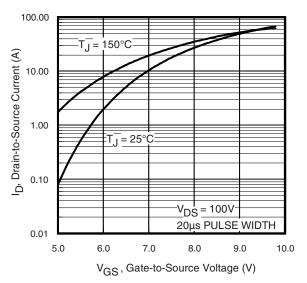


Fig. 3 - Typical Transfer Characteristics

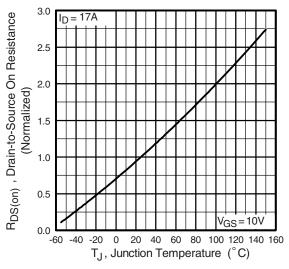


Fig. 4 - Normalized On-Resistance vs. Temperature



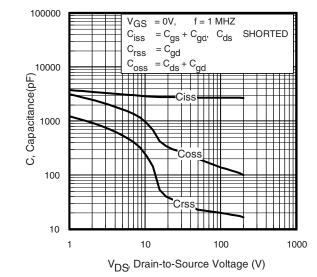


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

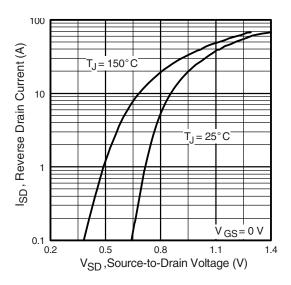


Fig. 7 - Typical Source-Drain Diode Forward Voltage

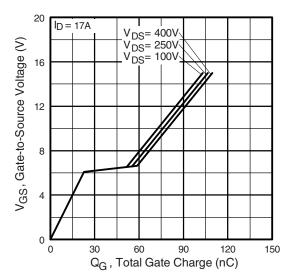


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

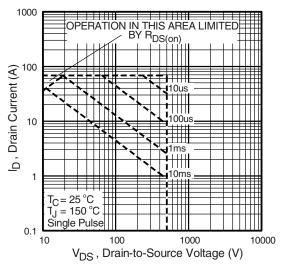


Fig. 8 - Maximum Safe Operating Area



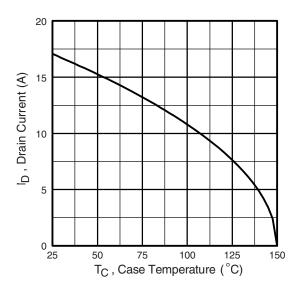


Fig. 9 - Maximum Drain Current vs. Case Temperature

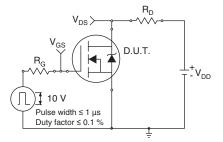


Fig. 10a - Switching Time Test Circuit

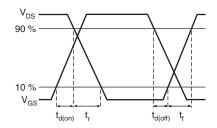


Fig. 10b - Switching Time Waveforms

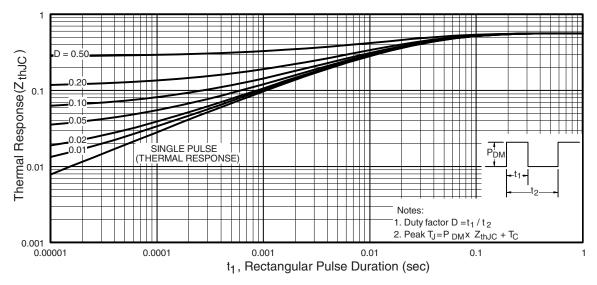
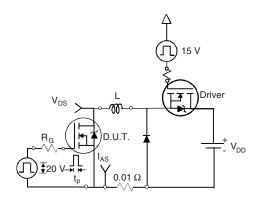


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





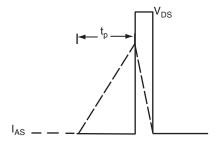


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

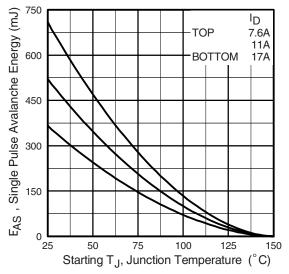


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

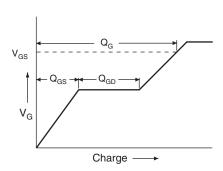


Fig. 13a - Basic Gate Charge Waveform

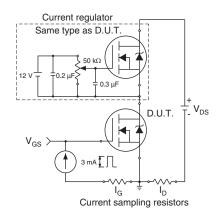
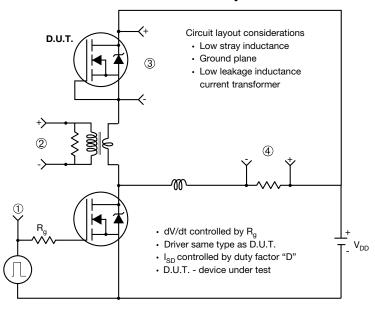


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



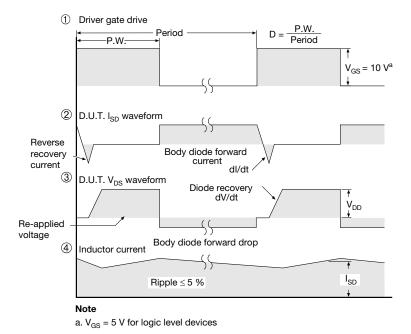
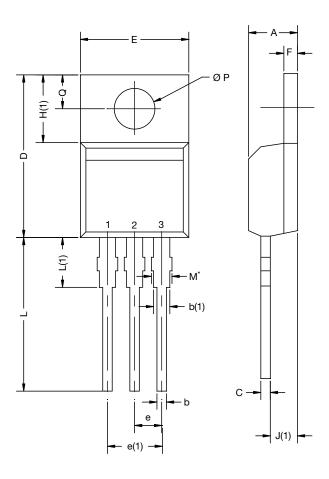


Fig. 14 - For N-Channel

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# TO-220-1



DIM.	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØP	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

•  $M^* = 0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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